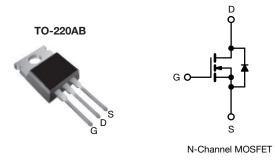
**Vishay Siliconix** 



# **E Series Power MOSFET**



PRODUCT SUMMARY					
V <sub>DS</sub> (V) at T <sub>J</sub> max.	650				
R <sub>DS(on)</sub> typ. (Ω) at 25 °C	V <sub>GS</sub> = 10 V 0.60				
Q <sub>g</sub> max. (nC)	12				
Q <sub>gs</sub> (nC)	3				
Q <sub>gd</sub> (nC)	3				
Configuration	Single				

### **FEATURES**

- 4<sup>th</sup> generation E series technology
- Low figure-of-merit (FOM) Ron x Qg
- Low effective capacitance (Co(er))
- · Reduced switching and conduction losses
- Avalanche energy rated (UIS)
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

### **APPLICATIONS**

- · Server and telecom power supplies
- Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- Lighting
  - High-intensity discharge (HID)
  - Fluorescent ballast lighting
- Industrial
  - Welding
  - Induction heating
  - Motor drives
  - Battery chargers
  - Solar (PV inverters)

ORDERING INFORMATION	
Package	TO-220AB
Lead (Pb)-free and halogen-free	SiHP690N60E-GE3

PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-source voltage			V <sub>DS</sub>	600	V	
Gate-source voltage			V <sub>GS</sub>	± 30	V	
Continuous drain surrant (T 150 °C)	V <sub>GS</sub> at 10 V	$T_{\rm C} = 25 \ ^{\circ}{\rm C}$ $T_{\rm C} = 100 \ ^{\circ}{\rm C}$	- I <sub>D</sub> -	6.4		
Continuous drain current ( $T_J = 150 \ ^{\circ}C$ )	VGS at 10 V	T <sub>C</sub> = 100 °C		4.0	А	
Pulsed drain current <sup>a</sup>			I <sub>DM</sub>	11		
Linear derating factor				0.5	W/°C	
Single pulse avalanche energy <sup>b</sup>			E <sub>AS</sub>	9	mJ	
Maximum power dissipation			PD	62.5	W	
Operating junction and storage temperature range			T <sub>J</sub> , T <sub>stg</sub>	-55 to +150	°C	
Drain-source voltage slope $T_J = 125 \text{ °C}$		dy /dt	70			
Reverse diode dv/dt <sup>d</sup>		dv/dt	17	V/ns		
Soldering recommendations (peak temperature) <sup>c</sup>		For 10 s		260	°C	

#### Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature
- b.  $V_{DD}$  = 120 V, starting T<sub>J</sub> = 25 °C, L = 28.2 mH, R<sub>q</sub> = 25  $\Omega$ , I<sub>AS</sub> = 0.8 A

c. 1.6 mm from case

d.  $I_{SD} \leq I_D$ , di/dt = 100 A/µs, starting  $T_J$  = 25 °C

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THERMAL RESISTANCE RAT	INGS							
PARAMETER	SYMBOL	TYP.		MAX.			UNIT	
Maximum junction-to-ambient	R <sub>thJA</sub>	-		62		°C M/		
Maximum junction-to-case (drain)	R <sub>thJC</sub>	-		2.0		°C/W		
SPECIFICATIONS (T_J = 25 $^\circ C, \tau$	unless otherwi	se noted)						
PARAMETER	SYMBOL	TES	T CONDIT	IONS	MIN.	TYP.	MAX.	UNIT
Static								
Drain-source breakdown voltage	V <sub>DS</sub>	V <sub>GS</sub> =	= 0 V, I <sub>D</sub> = 2	250 μΑ	600	-	-	V
V <sub>DS</sub> temperature coefficient	$\Delta V_{DS}/T_{J}$	Referenc	e to 25 °C,	I <sub>D</sub> = 1 mA	-	0.73	-	V/°C
Gate-source threshold voltage (N)	V <sub>GS(th)</sub>	V <sub>DS</sub> =	$V_{GS}, I_D = 2$	250 µA	3.0	-	5.0	V
		1	$V_{GS} = \pm 20 V$		-	-	± 100	nA
Gate-source leakage	I <sub>GSS</sub>	1	$V_{GS} = \pm 30 \text{ V}$		-	-	± 1	μA
		V <sub>DS</sub> =	600 V, V <sub>G</sub>	<sub>S</sub> = 0 V	-	-	1	
Zero gate voltage drain current	IDSS	V <sub>DS</sub> = 480 V	, V <sub>GS</sub> = 0 V	∕, T <sub>J</sub> = 125 °C	-	-	10	μA
Drain-source on-state resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> = 10 V	١ <sub>٢</sub>	<sub>0</sub> = 2.0 A	-	0.60	0.70	Ω
Forward transconductance a	9 <sub>fs</sub>	V <sub>DS</sub> =	= 20 V, I <sub>D</sub> =	= 2.0 A	-	1.2	-	S
Dynamic					•	•	•	
Input capacitance	C <sub>iss</sub>		V <sub>GS</sub> = 0 V		-	347	-	1
Output capacitance	C <sub>oss</sub>	$V_{\text{DS}} = 100 \text{ V},$ f = 1  MHz		-	24	-	pF	
Reverse transfer capacitance	C <sub>rss</sub>			-	4	-		
Effective output capacitance, energy related <sup>a</sup>	C <sub>o(er)</sub>	– V <sub>DS</sub> = 0 V to 480 V, V <sub>GS</sub> = 0 V		-	17	-		
Effective output capacitance, time related <sup>b</sup>	C <sub>o(tr)</sub>			-	86	-		
Total gate charge	Qg				-	8	12	
Gate-source charge	Q <sub>gs</sub>	V <sub>GS</sub> = 10 V	I <sub>D</sub> = 2.0	A, V <sub>DS</sub> = 480 V	-	3	-	nC
Gate-drain charge	Q <sub>gd</sub>				-	3	-	
Turn-on delay time	t <sub>d(on)</sub>				-	12	24	
Rise time	tr	V <sub>DD</sub> = 480 V, I <sub>D</sub> = 2.0 A,		-	9	18		
Turn-off delay time	t <sub>d(off)</sub>	V <sub>GS</sub> =	= 10 V, R <sub>g</sub> =	= 9.1 Ω <sup>´</sup>	-	19	38	ns
Fall time	t <sub>f</sub>	-		-	22	44	1	
Gate input resistance	R <sub>g</sub>	f = 1 MHz, open drain		1.1	2.3	4.6	Ω	
Drain-Source Body Diode Characterist						<b>I</b>	<b>I</b>	
Continuous source-drain diode current	I <sub>S</sub>	MOSFET symbol showing the integral reverse p - n junction diode		-	-	6.4	A	
Pulsed diode forward current	I <sub>SM</sub>			-	-	11		
Diode forward voltage	V <sub>SD</sub>	T <sub>.1</sub> = 25 °C	, I <sub>S</sub> = 2.0 A	A, V <sub>GS</sub> = 0 V	-	-	1.2	V
Reverse recovery time	t <sub>rr</sub>				-	146	292	ns
Reverse recovery charge	Q <sub>rr</sub>	T <sub>J</sub> = 25	°C, $I_F = I_S$	= 2.0 A,	-	1.0	2.0	μC
Reverse recovery current	I <sub>RRM</sub>	di/dt = `	100 A/µs, \	/ <sub>R</sub> = 25 V	-	13	-	A
	•KKIVI				I			

#### Notes

a.  $C_{oss(er)}$  is a fixed capacitance that gives the same energy as  $C_{oss}$  while  $V_{DS}$  is rising from 0 % to 80 %  $V_{DSS}$ 

b.  $C_{oss(tr)}$  is a fixed capacitance that gives the same charging time as  $C_{oss}$  while  $V_{DS}$  is rising from 0 % to 80 %  $V_{DSS}$ 

2



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### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

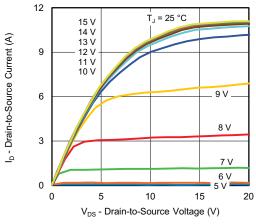


Fig. 1 - Typical Output Characteristics

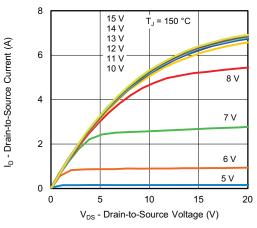


Fig. 2 - Typical Output Characteristics

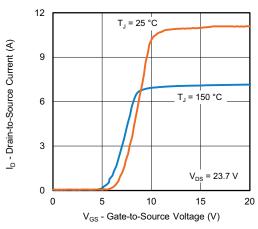


Fig. 3 - Typical Transfer Characteristics

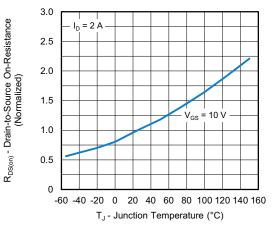


Fig. 4 - Normalized On-Resistance vs. Temperature

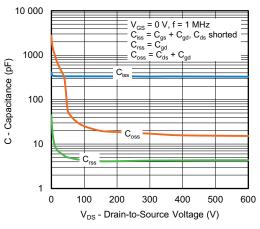


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

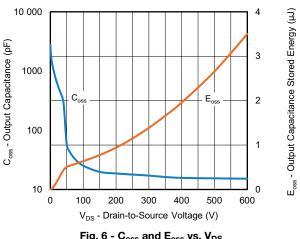


Fig. 6 - Coss and Eoss vs. VDS

S19-0493-Rev. A, 17-Jun-2019

3 For technical questions, contact: hvm@vishay.com Document Number: 92274

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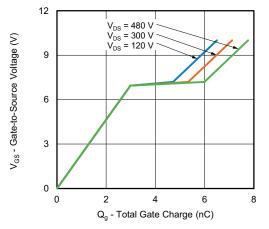


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

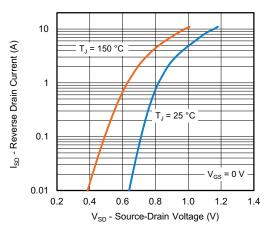


Fig. 8 - Typical Source-Drain Diode Forward Voltage

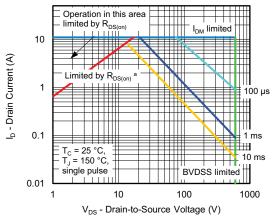


Fig. 9 - Maximum Safe Operating Area

Note

a.  $V_{GS}$  > minimum  $V_{GS}$  at which  $R_{DS(on)}$  is specified

4

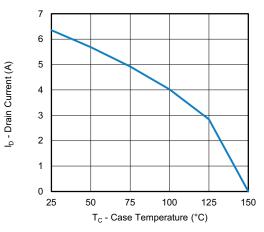


Fig. 10 - Maximum Drain Current vs. Case Temperature

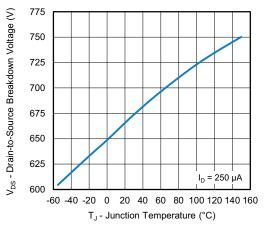


Fig. 11 - Temperature vs. Drain-to-Source Voltage

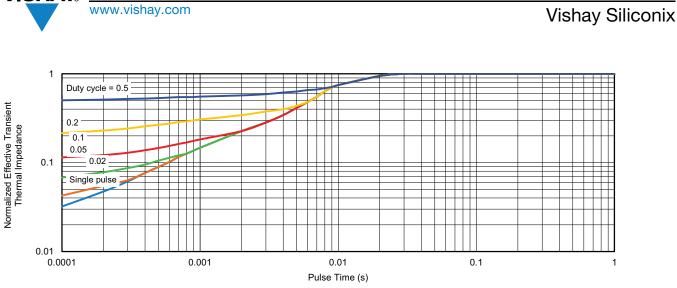


Fig. 12 - Normalized Transient Thermal Impedance, Junction-to-Case

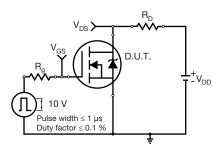


Fig. 13 - Switching Time Test Circuit

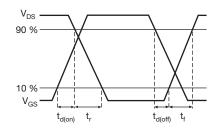


Fig. 14 - Switching Time Waveforms

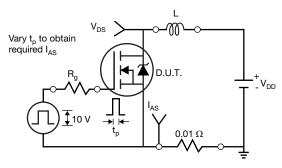


Fig. 15 - Unclamped Inductive Test Circuit

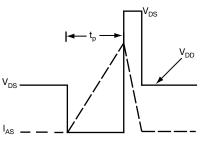


Fig. 16 - Unclamped Inductive Waveforms

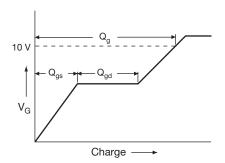


Fig. 17 - Basic Gate Charge Waveform

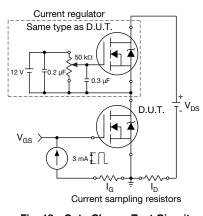
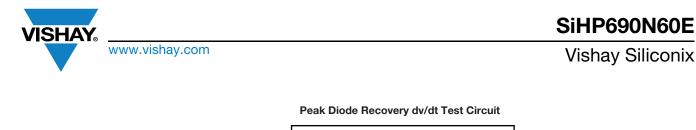


Fig. 18 - Gate Charge Test Circuit

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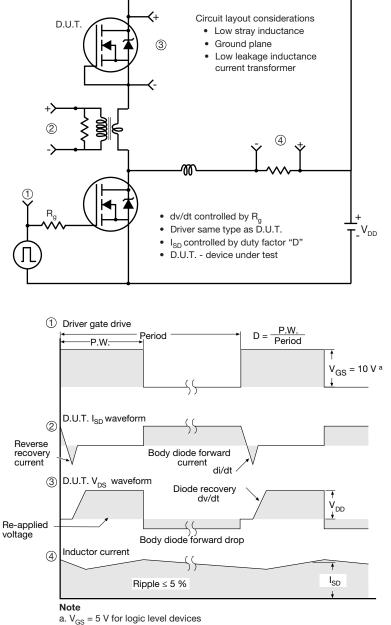


Fig. 19 - For N-Channel

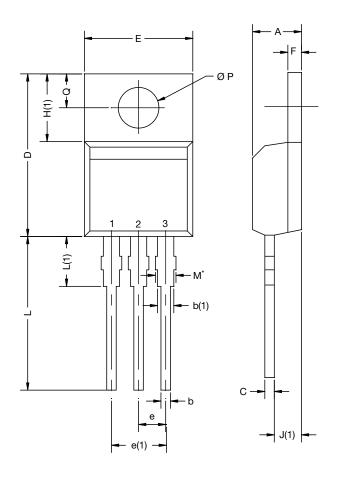
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6



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TO-220-1



DIM	MILLIN	METERS	INC	HES
DIM.	MIN.	MAX.	MIN.	MAX.
А	4.24	4.65	0.167	0.183
b	0.69	1.02	0.027	0.040
b(1)	1.14	1.78	0.045	0.070
С	0.36	0.61	0.014	0.024
D	14.33	15.85	0.564	0.624
E	9.96	10.52	0.392	0.414
е	2.41	2.67	0.095	0.105
e(1)	4.88	5.28	0.192	0.208
F	1.14	1.40	0.045	0.055
H(1)	6.10	6.71	0.240	0.264
J(1)	2.41	2.92	0.095	0.115
L	13.36	14.40	0.526	0.567
L(1)	3.33	4.04	0.131	0.159
ØP	3.53	3.94	0.139	0.155
Q	2.54	3.00	0.100	0.118

### Note

• M\* = 0.052 inches to 0.064 inches (dimension including protrusion), heatsink hole for HVM

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